

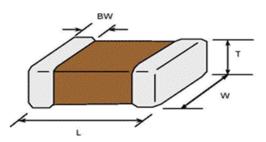


SPECIFICATION (Reference sheet)

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- A. Samsung Part Number

		<u>CL</u>	<u>31</u>	<u>B</u>	<u>225</u>	<u>K</u>	<u>C</u>	<u>H</u>	<u>S</u>	<u>N</u>	<u>N</u>	E	
		1	2	3	4	5	6	1	8	9	10	1	
\bigcirc	Series	Samsung Mult		r Cor	amic (ana	citor						
\smile		-	•			•	± 0.2	,			W:	1.6 + 0.2	
	Size	1206 (inch o	code)		L.	3.Z	± 0.2		mm		٧٧.	1.0 ± 0.2	
3	Dielectric	X7R				8	Inne	r ele	ctro	de		Ni	
4	Capacitance	2.2 μF					Tern	nina	tion			Soft Termina	ation
5	Capacitance	±10 %					Plati	ng				Sn 100%	(Pb Free)
	tolerance					9	Proc	luct				Normal	
6	Rated Voltage	100 V				10	Spee	cial				Reserved for	r future use
\bigcirc	Thickness	1.6 ± 0.2	mm			1	Pac	kagii	ng			Embossed T	ype, 7" reel

B. Structure and dimension



Samsung P/N	Dimension(mm)								
	L	W	Т	BW					
CL31B225KCHSNNE	3.2±0.2	1.6±0.2	1.6±0.2	0.5±0.3					

- Samsung P/N : CL31B225KCHSNNE
- Description : CAP, 2.2 µF, 100V, ±10%, X7R, 1206

C. Samsung Reliability Test and Judgement condition

	Performance	Test condition			
Capacitance	Within specified tolerance	1k ⁻ / _b ±10% 1.0±0.2Vrms *A capacitor prior to measuring the capacitance is heat treated at 150 °C+0/-10 °C for 1 hour and maintained in			
Tan δ (DF)	0.1 max.	ambient air for 24±2 hours.			
Insulation	10,000Mohm or 100Mohm·µF	Rated Voltage 60±5 sec.			
Resistance	Whichever is smaller				
Appearance	No abnormal exterior appearance	Visual inspection			
Withstanding	No dielectric breakdown or	200% of the rated voltage			
Voltage	mechanical breakdown				
Temperature	X7R				
Characteristics	(From -55℃ to 125℃, Capacitance cha	nge should be within ±15%)			
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.			
of Termination	terminal electrode				
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)			
		with 1.0mm/sec.			
Solderability	More than 95% of terminal surface	SnAg3.0Cu0.5 solder			
	is to be soldered newly	245±5℃, 3±0.3sec.			
		(preheating : 80~120 ℃ for 10~30sec.)			
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.			
Soldering heat	Tan δ, IR : initial spec.				
Vibration Test	Capacitance change : within ±5%	Amplitude : 1.5mm			
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)			
		2hours \times 3 direction (x, y, z)			
Moisture	Capacitance change : within ±12.5%	With rated voltage			
Resistance	Tan δ:0.125 max	40±2℃, 90~95%RH, 500+12/-0 hours			
	IR : 500Mohm or 12.5Mohm · <i>μ</i> F				
	Whichever is Smaller				
High Temperature	Capacitance change : within ±12.5%	With 150% of the rated voltage			
Resistance	Tan δ:0.125 max	Max. operating temperature			
	IR : 1,000Mohm or 25Mohm · μF				
	Whichever is Smaller	1000+48/-0 hours			
Temperature	Capacitance change : within ±7.5%	1 cycle condition			
Cycling	Tan δ, IR : initial spec.	Min. operating temperature $\rightarrow 25^{\circ}$ C			
_		\rightarrow Max. operating temperature \rightarrow 25 °C			
		5 cycles test			

X The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 250 °C, 6sec. max.)

A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

- Disclaimer & Limitation of Use and Application -

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury. We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- Aerospace/Aviation equipment
- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- *④ Military equipment*
- *5* Disaster prevention/crime prevention equipment
- *ⓐ* Any other applications with the same as or similar complexity or reliability to the applications set forth above.